

V_{RRM} = 2500 V
 I_{FAVM} = 950 A
 I_{FSM} = 21 kA
 V_{F0} = 1.2 V
 r_F = 0.38 mΩ
 V_{DClink} = 1500 V

Fast Recovery Diode

5SDF 11F2501

Doc. No. 5SYA1113-04 Sep. 01

- Patented free-floating silicon technology
- Low on-state and switching losses
- Optimized for use as freewheeling diode in GTO converters
- Standard press-pack housing, hermetically cold-welded
- Cosmic radiation withstand rating

Blocking

V_{RRM}	Repetitive peak reverse voltage	2500 V	Half sine wave, $t_P = 10$ ms, $f = 50$ Hz	
I_{RRM}	Repetitive peak reverse current	≤ 50 mA	$V_R = V_{RRM}, T_j = 125^\circ\text{C}$	
V_{DClink}	Permanent DC voltage for 100 FIT failure rate	1500 V	100% Duty	Ambient cosmic radiation at sea level in open air.
V_{DClink}	Permanent DC voltage for 100 FIT failure rate	V	5% Duty	

Mechanical data (see Fig. 12)

F_m	Mounting force	min.	20 kN	
		max.	24 kN	
a	Acceleration: Device unclamped Device clamped		50 m/s ² 200 m/s ²	
m	Weight		0.46 kg	
D_s	Surface creepage distance	\geq	30 mm	
D_a	Air strike distance	\geq	20 mm	

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On-state (see Fig. 2, 3)

I_{FAVM}	Max. average on-state current	950 A	Half sine wave, $T_c = 85^\circ\text{C}$		
I_{FRMS}	Max. RMS on-state current	1500 A			
I_{FSM}	Max. peak non-repetitive surge current	21 kA	$tp = 10 \text{ ms}$	Before surge: $T_c = T_j = 125^\circ\text{C}$	
		65 kA	$tp = 1 \text{ ms}$		
$\int i^2 dt$	Max. surge current integral	$2.2 \cdot 10^6 \text{ A}^2\text{s}$	$tp = 10 \text{ ms}$	After surge: $V_R \approx 0 \text{ V}$	
		$2.1 \cdot 10^6 \text{ A}^2\text{s}$	$tp = 1 \text{ ms}$		
V_F	Forward voltage drop	$\leq 1.6 \text{ V}$	$I_F = 1000 \text{ A}$	$T_j = 125^\circ\text{C}$	
V_{FO}	Threshold voltage	1.2 V	Approximation for		
r_F	Slope resistance	0.38 mΩ	$I_F = 400...4000 \text{ A}$		

Turn-on (see Fig. 4, 5)

V_{fr}	Peak forward recovery voltage	$\leq 16 \text{ V}$	$di/dt = 500 \text{ A}/\mu\text{s}, T_j = 125^\circ\text{C}$
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Turn-off (see Fig. 6 to 11)

I_{rr}	Reverse recovery current	$\leq 550 \text{ A}$	$di/dt = 300 \text{ A}/\mu\text{s}, I_F = 700 \text{ A},$
Q_{rr}	Reverse recovery charge	$\leq 1200 \mu\text{C}$	$T_j = 125^\circ\text{C}, V_{RM} = 2600 \text{ V},$
E_{rr}	Turn-off energy	$\leq 0.45 \text{ J}$	$C_S = 2\mu\text{F}$ (GTO snubber circuit)

Thermal (see Fig. 1)

T_j	Operating junction temperature range	-40...125°C		
T_{stg}	Storage temperature range	-40...125°C		
R_{thJC}	Thermal resistance junction to case	$\leq 40 \text{ K/kW}$	Anode side cooled	$F_m = 20...24 \text{ kN}$
		$\leq 40 \text{ K/kW}$	Cathode side cooled	
		$\leq 20 \text{ K/kW}$	Double side cooled	
R_{thCH}	Thermal resistance case to heatsink	$\leq 10 \text{ K/kW}$	Single side cooled	
		$\leq 5 \text{ K/kW}$	Double side cooled	

Analytical function for transient thermal impedance.

$$Z_{thJC}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i(\text{K/kW})$	11.83	4.26	1.63	2.28
$\tau_i(\text{s})$	0.432	0.071	0.01	0.0054
$F_m = 20...24 \text{ kN}$ Double side cooled				

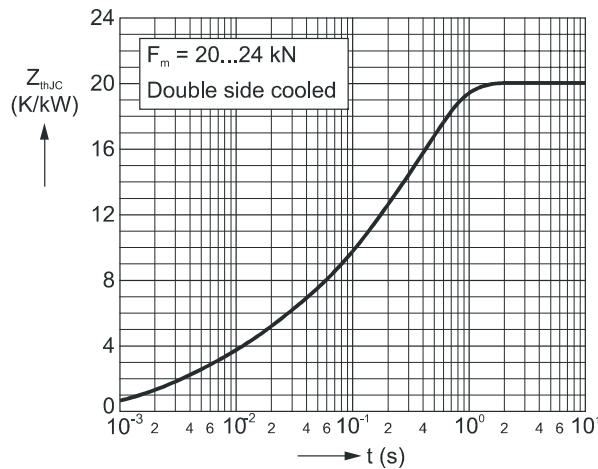


Fig. 1 Transient thermal impedance (junction-to-case) vs. time in analytical and graphical form (max. values).

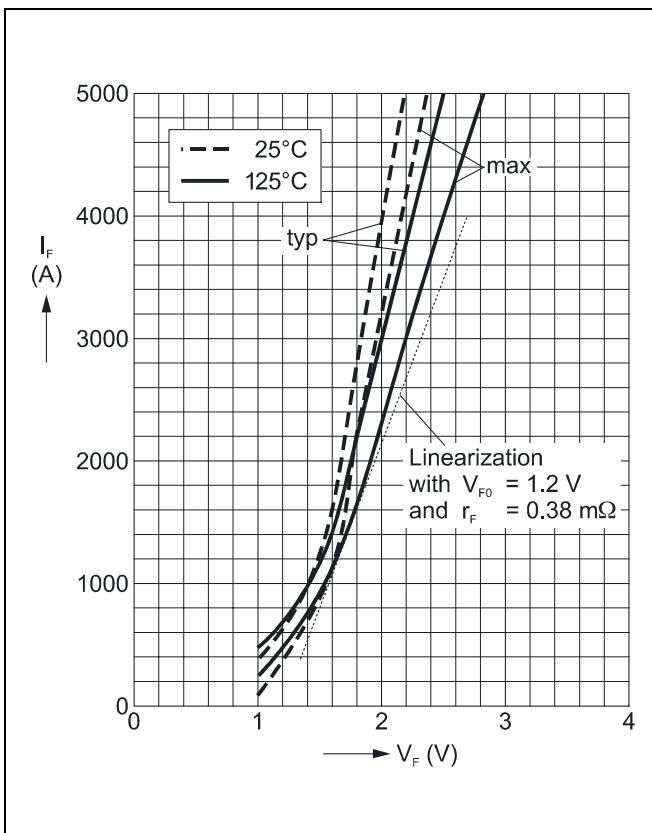


Fig. 2 Forward current vs. forward voltage (typ. and max. values) and linear approximation of max. curve at 125°C .

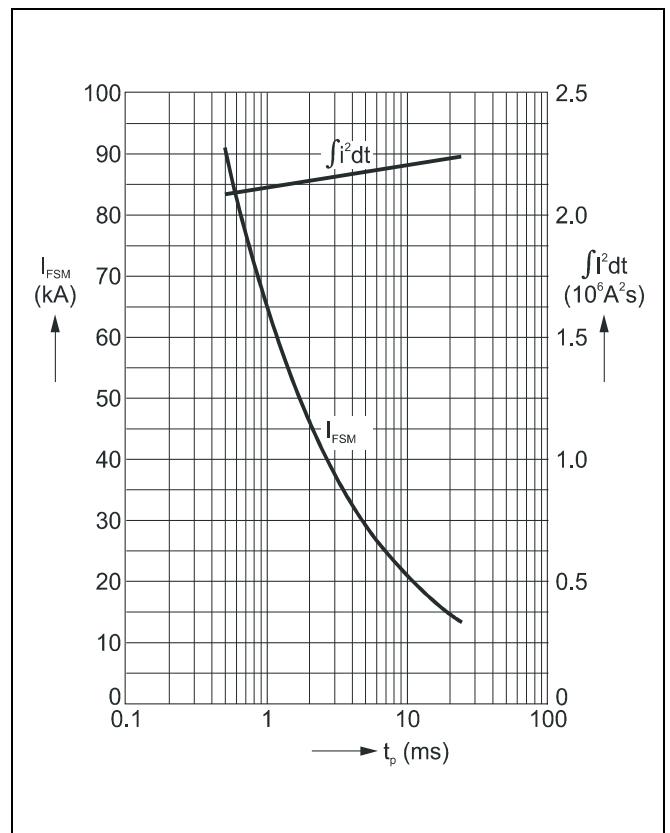
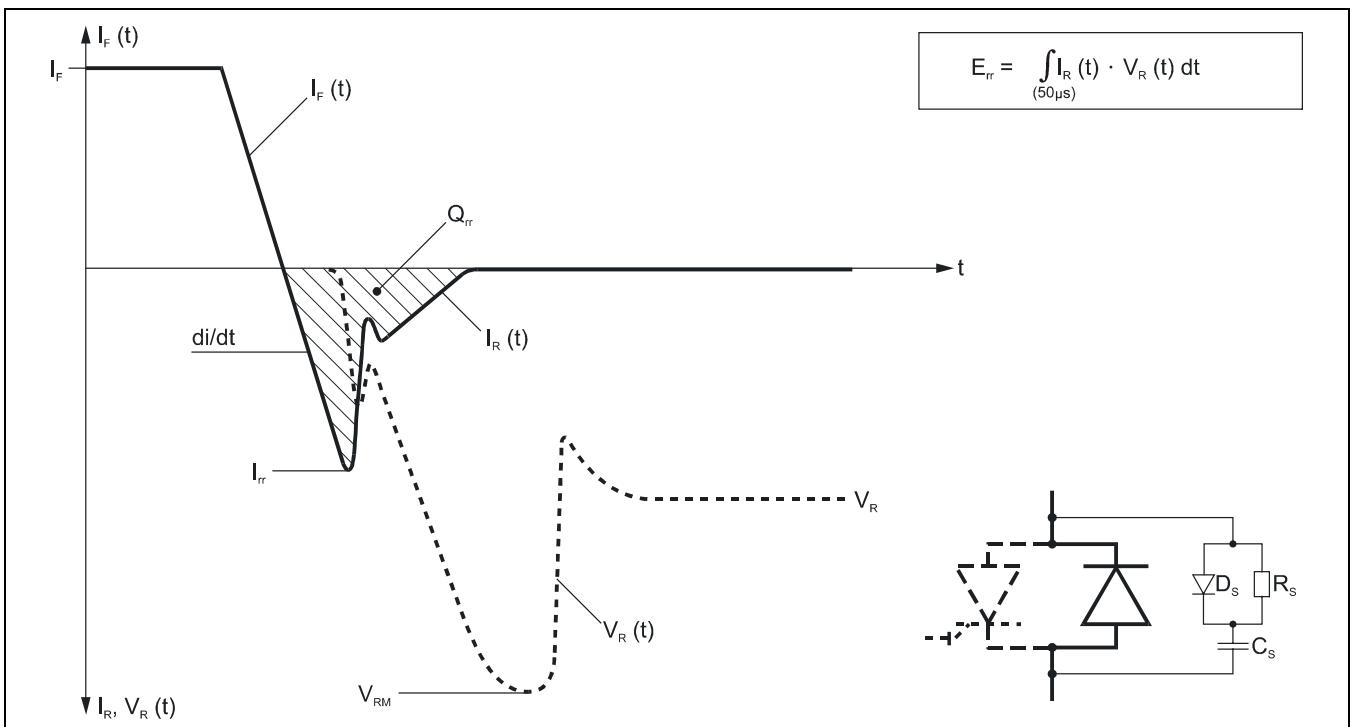
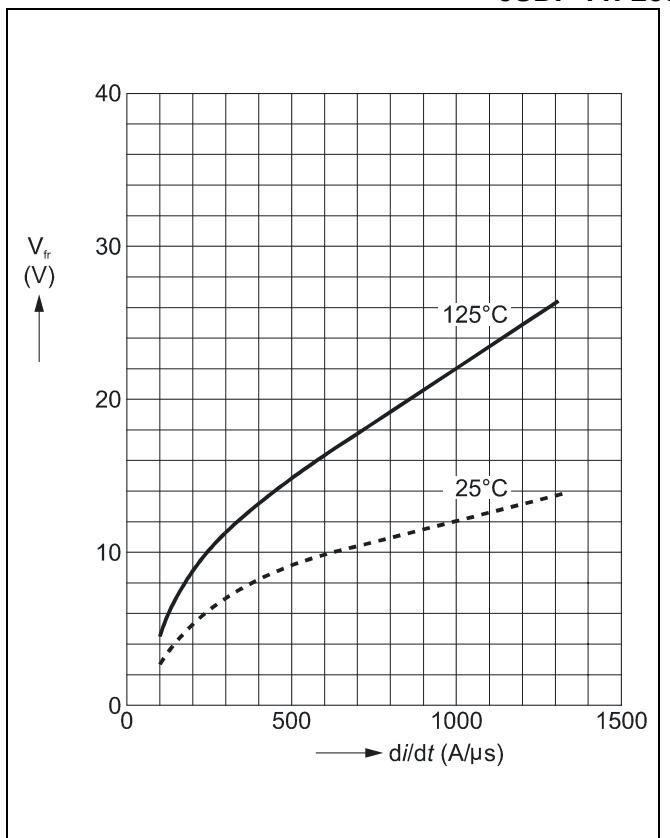
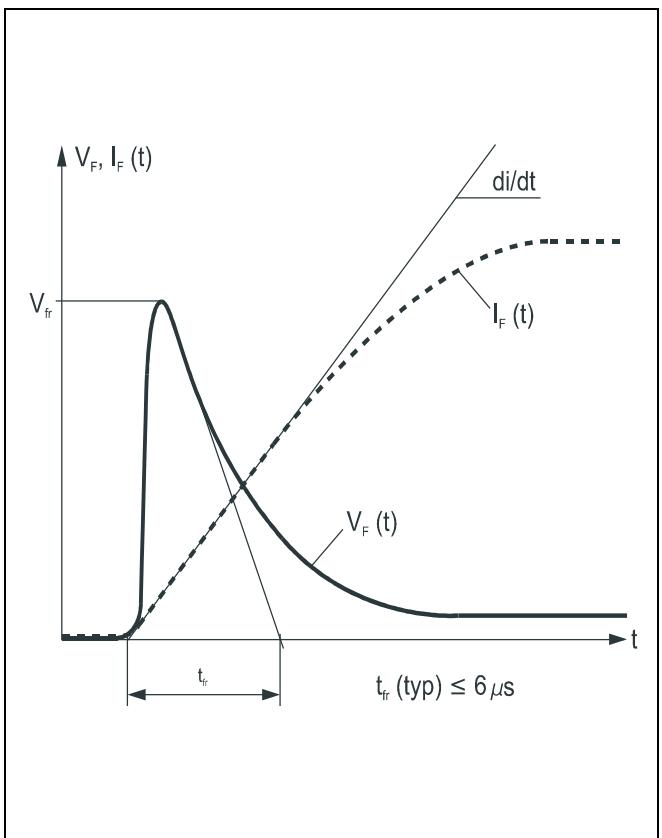


Fig. 3 Surge current and fusing integral vs. pulse width (max. values) for non-repetitive, half-sinusoidal surge current pulses.



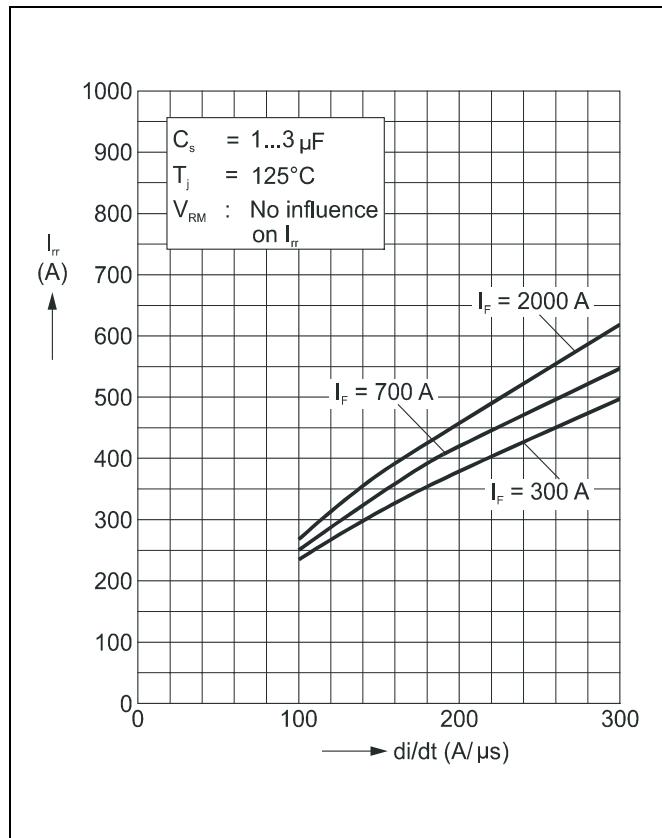


Fig. 7 Reverse recovery current vs. turn off di/dt (max. values).

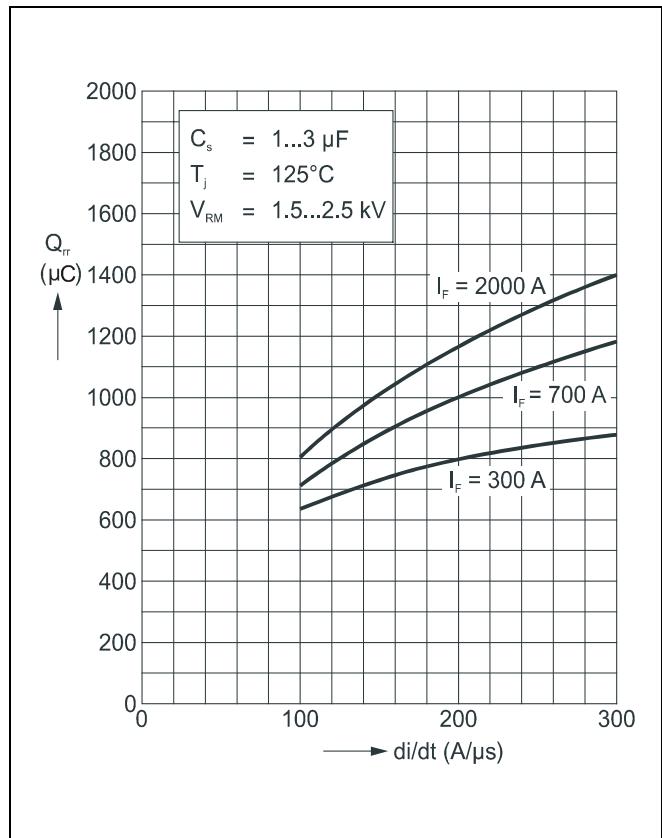


Fig. 8 Reverse recovery charge vs. turn off di/dt (max. values).

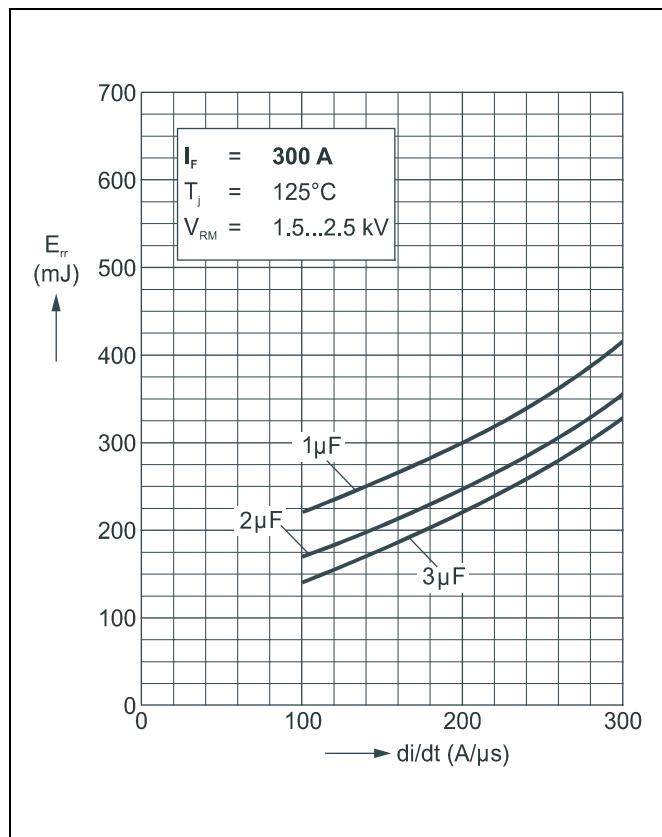


Fig. 9 Turn-off energy vs. turn-off di/dt for $I_F = 300$ A (max. values).

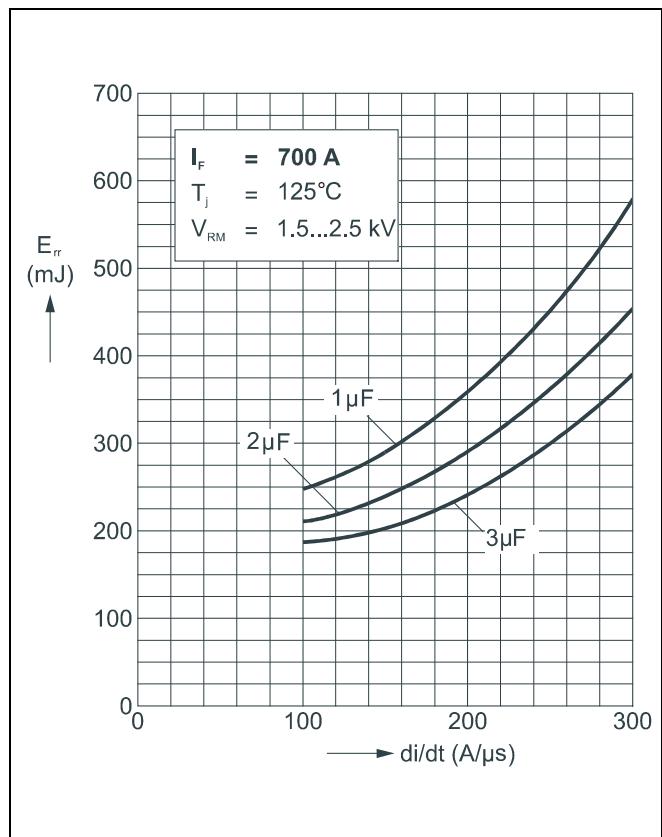


Fig. 10 Turn-off energy vs. turn-off di/dt for $I_F = 700$ A (max. values).

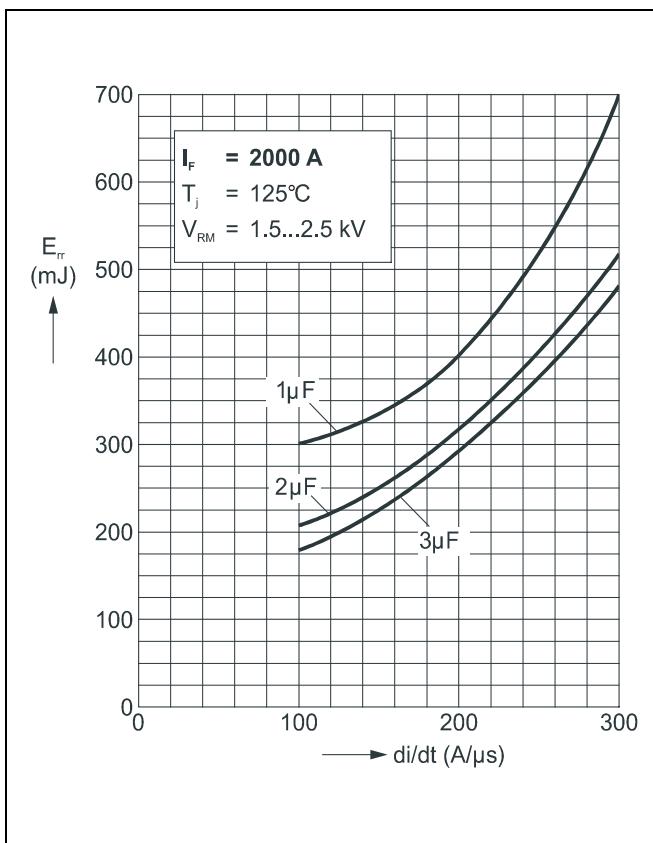


Fig. 11 Turn-off energy vs. turn-off di/dt for $I_F = 2000$ A (max. values).

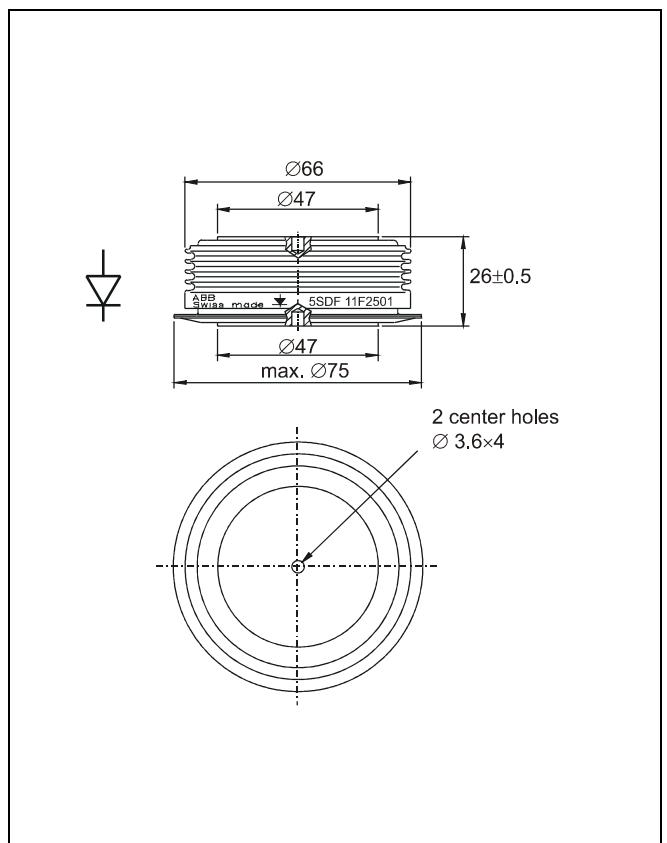


Fig. 12 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

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